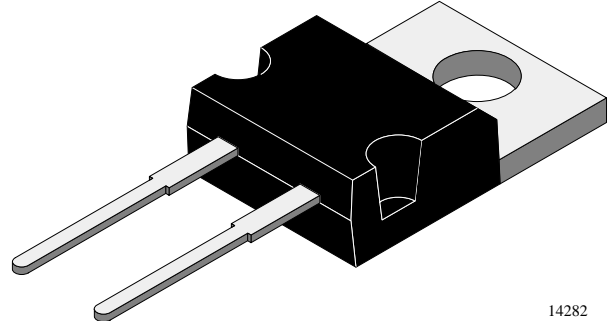


# Ultra Fast Recovery Silicon Power Rectifier

## Features

- Multiple diffusion
- Epitaxial – planar
- Ultra fast forward recovery time
- Ultra fast reverse recovery time
- Low reverse current
- Very good reverse current stability at high temperature
- Low thermal resistance



14282

## Applications

Fast rectifiers in S.M.P.S  
 Freewheeling diodes and snubber diodes in motor control circuits

## Absolute Maximum Ratings

 $T_j = 25^\circ\text{C}$ 

Parameter	Test Conditions	Type	Symbol	Value	Unit
Reverse voltage =Repetitive peak reverse voltage		BYT108/200	$V_R = V_{RRM}$	200	V
		BYT108/400	$V_R = V_{RRM}$	400	V
Peak forward surge current	$t_p = 10\text{ms}$ , half sinewave		$I_{FSM}$	100	A
Repetitive peak forward current			$I_{FRM}$	40	A
Average forward current			$I_{FAV}$	8	A
Junction and storage temperature range			$T_j = T_{stg}$	-55...+150	$^\circ\text{C}$

## Maximum Thermal Resistance

 $T_j = 25^\circ\text{C}$ 

Parameter	Test Conditions	Symbol	Value	Unit
Junction case		$R_{thJC}$	2.4	K/W
Junction ambient		$R_{thJA}$	85	K/W

### Electrical Characteristics

$T_j = 25^\circ\text{C}$

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F=8\text{A}$		$V_F$			1.3	V
	$I_F=8\text{A}, T_j=100^\circ\text{C}$		$V_F$			1.2	V
Reverse current	$V_R=V_{RRM}$		$I_R$			5	$\mu\text{A}$
	$V_R=V_{RRM}, T_j=150^\circ\text{C}$		$I_R$			1	mA
Forward recovery time	$I_F=8\text{A}, di_F/dt \leq 50\text{A}/\mu\text{s}$		$t_{fr}$		350		ns
Turn on transient peak voltage			$V_{FP}$			4	V
Reverse recovery characteristics	$I_F=8\text{A}, di_F/dt \leq -50\text{A}/\mu\text{s}, V_{Batt}=200\text{V}$		$I_{RM}$		5		A
			$t_{IRM}$		100		ns
Reverse recovery time	$I_F=0.5\text{A}, I_R=1\text{A}, i_R=0.25\text{A}$	BYT108/200	$t_{rr}$			35	ns
		BYT108/400	$t_{rr}$			50	ns
Reverse recovery current	$I_F=1\text{A}, di_F/dt \leq -50\text{A}/\mu\text{s}, V_{Batt}=200\text{V}$		$I_{RM}$		1.9		A
Reverse recovery time	$I_F=1\text{A}, di_F/dt \leq -50\text{A}/\mu\text{s}, V_{Batt}=200\text{V}, i_R=0.25 \times I_{RM}$		$t_{rr}$		58		ns

### Characteristics ( $T_j = 25^\circ\text{C}$ unless otherwise specified)

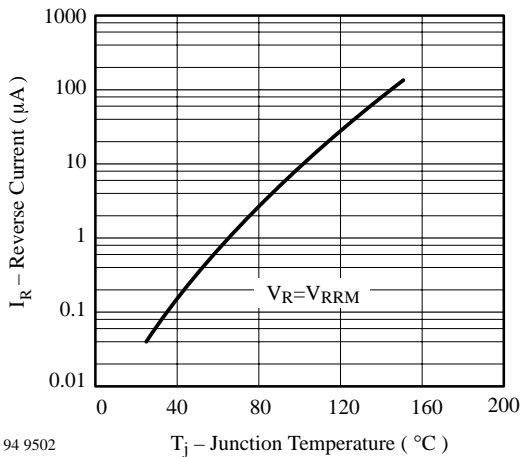


Figure 1. Typ. Reverse Current vs. Junction Temperature

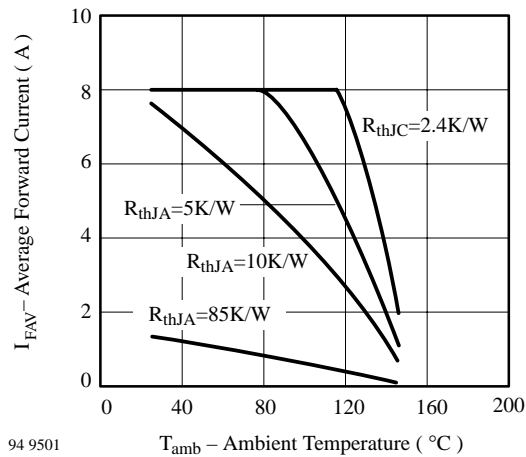


Figure 2. Max. Average Forward Current vs. Ambient Temperature

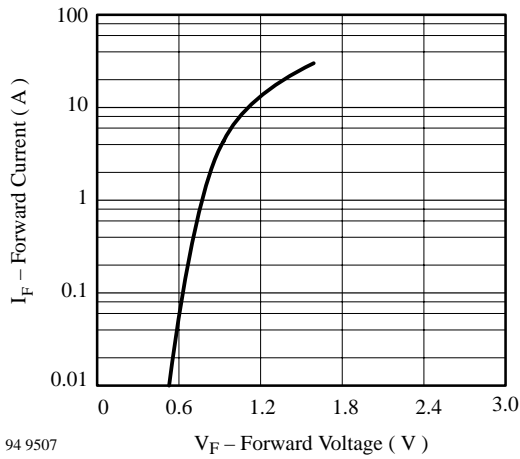


Figure 3. Typ. Forward Current vs. Forward Voltage

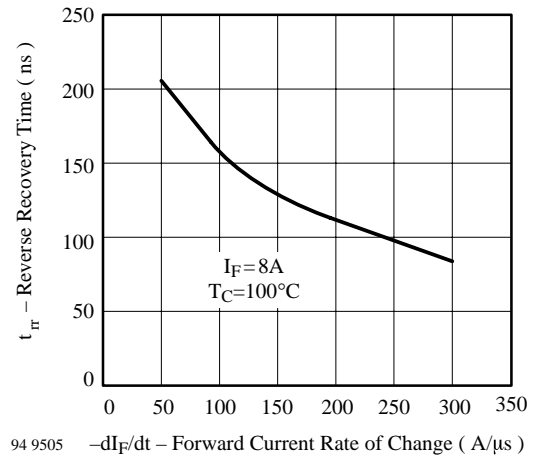


Figure 6. Reverse Recovery Time vs. Forward Current Rate of Change

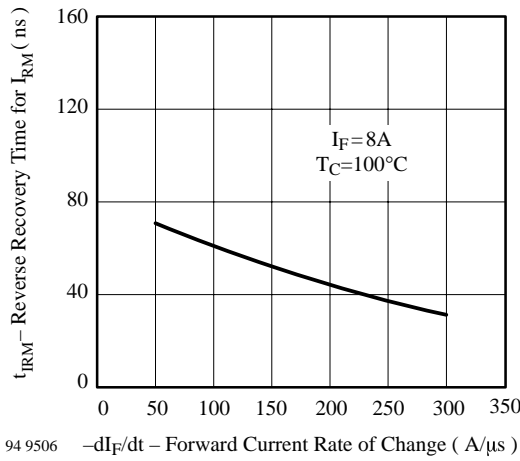


Figure 4. Reverse Recovery Time for  $I_{RM}$  vs. Forward Current Rate of Change

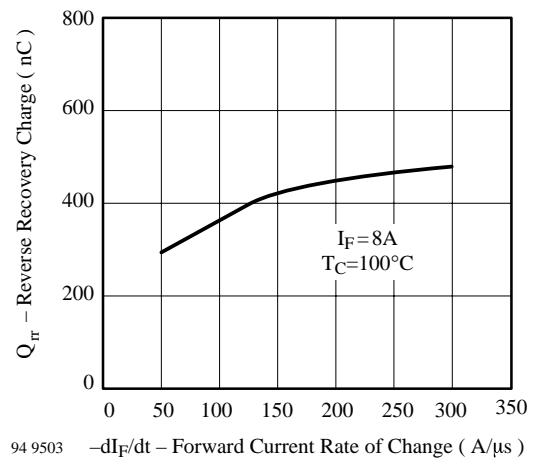


Figure 7. Reverse Recovery Charge vs. Forward Current Rate of Change

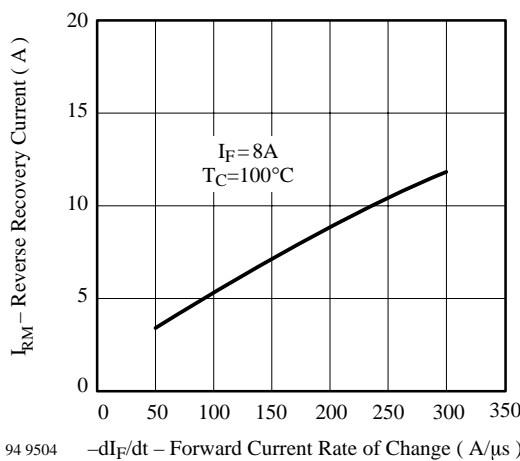
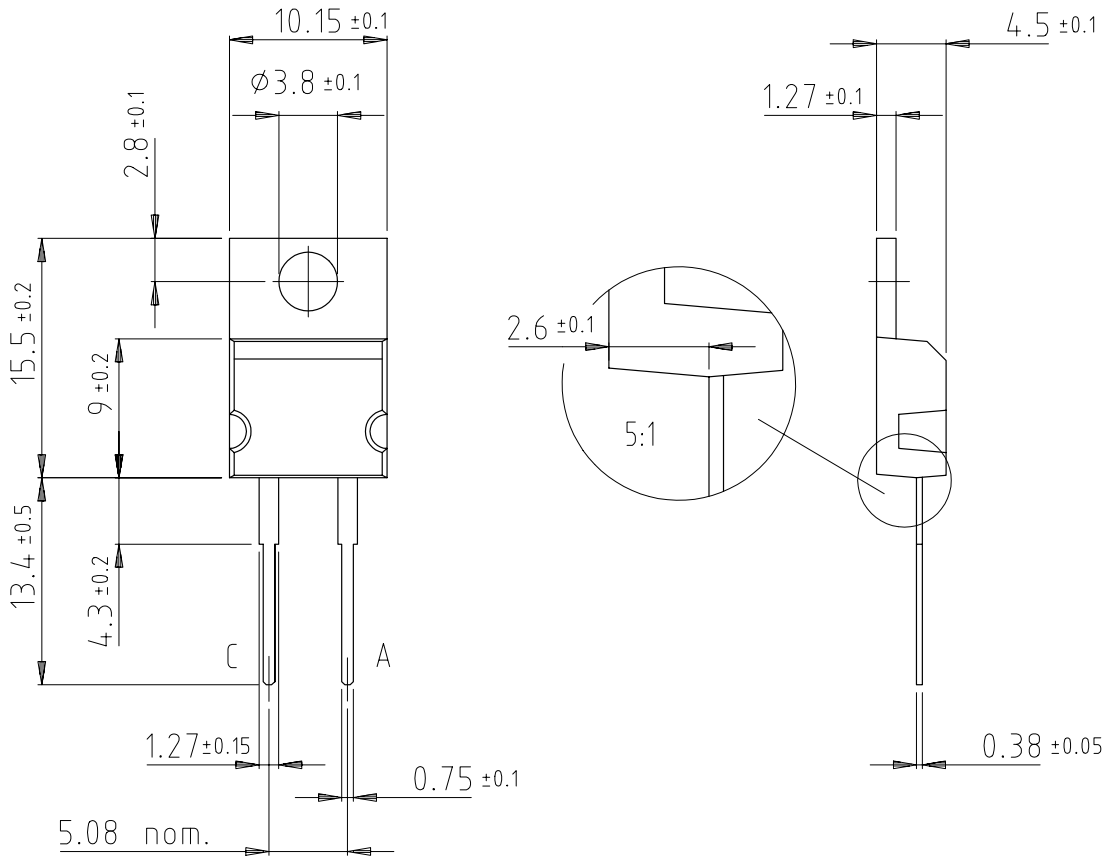
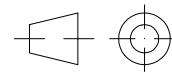


Figure 5. Reverse Recovery Current vs. Forward Current Rate of Change

### Dimensions in mm



Plastic case JEDEC DO 220  
Cathode connected with metallic surface



technical drawings  
according to DIN  
specifications

14276



## Ozone Depleting Substances Policy Statement

It is the policy of **Vishay Semiconductor GmbH** to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems  
with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

**Vishay Semiconductor GmbH** has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

**Vishay Semiconductor GmbH** can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

**We reserve the right to make changes to improve technical design and may do so without further notice.**

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay-Telefunken products for any unintended or unauthorized application, the buyer shall indemnify Vishay-Telefunken against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany  
Telephone: 49 (0) 7131 67 2831, Fax number: 49 (0) 7131 67 2423

This datasheet has been downloaded from:

[www.DatasheetCatalog.com](http://www.DatasheetCatalog.com)

Datasheets for electronic components.



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

[LittleDiode.com](http://LittleDiode.com)

Looking forward to providing you with the best possible service.